

Silicon Carbide Power MOSFET E-Series Automotive N-Channel Enhancement Mode

Features

- 3rd generation SiC MOSFET technology
- Optimized package with separate driver source pin
- 8mm of creepage distance between drain and source
- High blocking voltage with low on-resistance
- High-speed switching with low capacitances
- Fast intrinsic diode with low reverse recovery (Q_{rr})
- Halogen free, RoHS compliant
- Automotive Qualified (AEC-Q101) and PPAP Capable

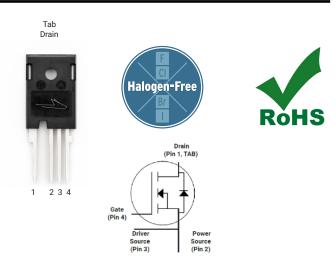
Benefits

- Reduce switching losses and minimize gate ringing
- Higher system efficiency
- Reduce cooling requirements
- Increase power density
- Increase system switching frequency

Applications

- Motor Control
- EV Battery Chargers
- High Voltage DC/DC Converters

Package



Part Number	Package	Marking
E3M0016120K	TO-247-4L	E3M0016120K

Maximum Ratings (T_c = 25 °C unless otherwise specified)

Symbol	Parameter	Value	Unit	Note	
V _{DSmax}	Drain - Source Voltage		1200	V	
V_{GSmax}	Gate - Source Voltage		-8/+19	V	Note: 1
	Continuous Drain Current, $V_{GS} = 15 \text{ V}$ $T_{C} = 25^{\circ}\text{C}$ $T_{C} = 100^{\circ}\text{C}$		125	A	Fig. 19 Note: 2
I _D			90		
I _{D(pulse)}	Pulsed Drain Current, Pulse width t_P limited by T_{jmax}	321	А	Fig. 22	
P _D	Power Dissipation, $T_c = 25^{\circ}C$, $T_J = 175^{\circ}C$			W	Fig. 20 Note: 2
T_{J} , T_{stg}	Operating Junction and Storage Temperature		-55 to +175	°C	
Τ _L	Solder Temperature, 1.6mm (0.063") from case for 10s			°C	
M _d	Mounting Torque , M3 or 6-32 screw	1 8.8	Nm lbf-in		

Note (1): Recommended turn off / turn on gate voltage V_{GS} - 4V...0V / +15V

Note (2): Verified by design

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Symbol	Parameter	Min.	Тур.	Max.	Unit	Test Conditions	Note
$V_{(\text{BR})\text{DSS}}$	Drain-Source Breakdown Voltage	1200			V	V _{GS} = 0 V, I _D = 100 µA	
M		1.8	2.5	3.6	V	V _{DS} = V _{GS} , I _D = 22.08 mA	Fig. 11
$V_{GS(th)}$	Gate Threshold Voltage		2.1		V	V_{DS} = V_{GS} , I_{D} = 22.08 mA, T_{J} = 175°C	
I _{DSS}	Zero Gate Voltage Drain Current		1	50	μA	V _{DS} = 1200 V, V _{GS} = 0 V	
I _{GSS}	Gate-Source Leakage Current		10	250	nA	V _{GS} = 15 V, V _{DS} = 0 V	
R _{DS(on)}	Drain-Source On-State Resistance	11	16	22	mΩ	V _{GS} = 15 V, I _D = 80.28 A	Fig. 4,
• DS(on)			29			V _{GS} = 15 V, I _D = 80.28 A, T _J = 175°C	5, 6
g fs	Transconductance		54		s	V _{DS} = 20 V, I _{DS} = 84.8 A	Fig. 7
3			49			V _{DS} = 20 V, I _{DS} = 80.9 A, T _J = 175°C	
C_{iss}	Input Capacitance		6922				
C_{oss}	Output Capacitance		231		pF	V_{GS} = 0 V, V_{DS} = 0V to 1000 V	Fig. 17, 18
C _{rss}	Reverse Transfer Capacitance		13		1	F = 100 kHz	
E _{oss}	Coss Stored Energy		127		μJ	Vac = 25 mV	Fig. 16
C _{o(er)}	Effective Output Capacitance (Energy Related)		268		pF	V _{GS} = 0 V, V _{DS} = 0 800V	Note: 3
C _{o(tr)}	Effective Output Capacitance (Time Related)		404		pF		
Eon	Turn-On Switching Energy (External Diode)		1287			V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_{D} = 80.28 A,	Fig. 26, 28
E _{OFF}	Turn Off Switching Energy (External Diode)		805		μJ	$R_{G(ext)}$ = 2.5 Ω, L= 59 µH, T _J = 175°C FWD = External SiC DIODE	
E _{on}	Turn-On Switching Energy (Body Diode FWD)		2552			V_{DS} = 800 V, V_{GS} = -4 V/15 V, I_{D} = 80.28 A,	Fig. 26, 28
E _{OFF}	Turn-Off Switching Energy (Body Diode FWD)		788		μJ	$R_{G(ext)} = 2.5 \Omega$, L= 135 µH, T _J = 175°C FWD = Internal Body Diode	
t _{d(on)}	Turn-On Delay Time		19				
tr	Rise Time		40		1	V_{DD} = 800 V, V_{GS} = -4 V/15 V I _D = 80.28 A, $R_{G(ext)}$ = 2.5 Ω,	Fig. 27, 28
$t_{\text{d(off)}}$	Turn-Off Delay Time		62		ns	Timing relative to V _{DS}	
t _f	Fall Time		13				
$R_{G(int)}$	Internal Gate Resistance		2.6		Ω	f = 1 MHz, V _{AC} = 25 mV	
Q_{gs}	Gate to Source Charge		70			V _{DS} = 800 V, V _{GS} = -4 V/15 V	
Q_{gd}	Gate to Drain Charge		65	1	nC	I _D = 80.28 A	Fig. 12
Q_g	Total Gate Charge		223			Per IEC60747-8-4 pg 21	

Electrical Characteristics ($T_c = 25^{\circ}C$ unless otherwise specified)

Note (3): $C_{o(er)}$, a lumped capacitance that gives same stored energy as Coss while Vds is rising from 0 to 800V $C_{o(tr)}$, a lumped capacitance that gives same charging time as Coss while Vds is rising from 0 to 800V

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Reverse Diode Characteristics (T_c = 25°C unless otherwise specified)

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
V	Dia la Famura IV (la ma	4.9		V	$V_{_{GS}}$ = -4 V, I $_{_{SD}}$ = 40.14 A, T $_{_{J}}$ = 25 °C	Fig. 8,
V _{SD}	Diode Forward Voltage	4.4		V	V _{gs} = -4 V, I _{sp} = 40.14 A, T _J = 175 °C	9,10
Is	Continuous Diode Forward Current		88	А	V _{gs} = -4 V, T _c = 25°C	
I _{S, pulse}	Diode pulse Current		321	А	V_{GS} = -4 V, pulse width t_P limited by T_{jmax}	
t _{rr}	Reverse Recover time	32		ns		
Q _{rr}	Reverse Recovery Charge	1665		nC	V _{cs} = -4 V, I _{sb} = 80.28 A, V _R = 800 V dif/dt = 5180 A/µs, T _J = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	82		A		
t _{rr}	Reverse Recover time	46		ns		
Q _{rr}	Reverse Recovery Charge	1365		nC	V _{GS} = -4 V, I _{SD} = 80.28 A, V _R = 800 V dif/dt = 2760 A/μs, Τ ₁ = 175 °C	
I _{rrm}	Peak Reverse Recovery Current	45		А		

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit	Test Conditions	Note
R _{0JC}	Thermal Resistance from Junction to Case	0.23	0.31	°C/W		Fig. 21



Typical Performance

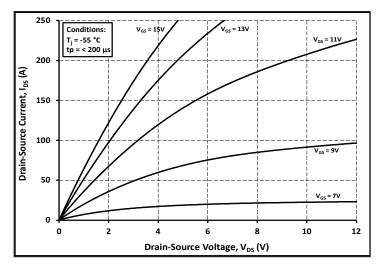
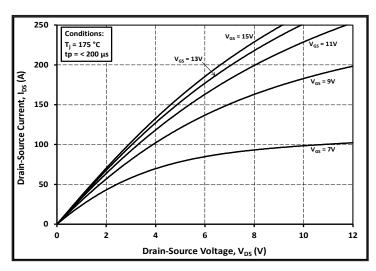
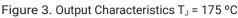


Figure 1. Output Characteristics T_J = -55 °C





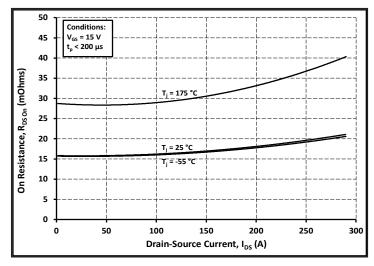


Figure 5. On-Resistance vs. Drain Current For Various Temperatures

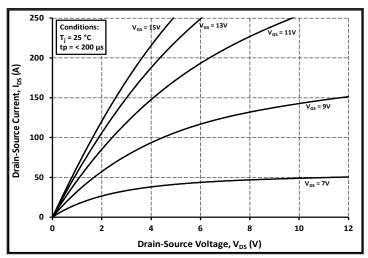


Figure 2. Output Characteristics T_J = 25 °C

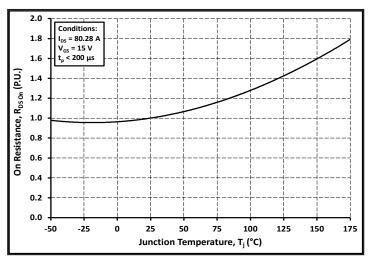


Figure 4. Normalized On-Resistance vs. Temperature

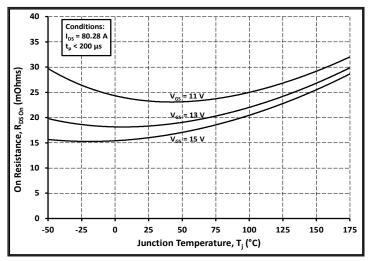


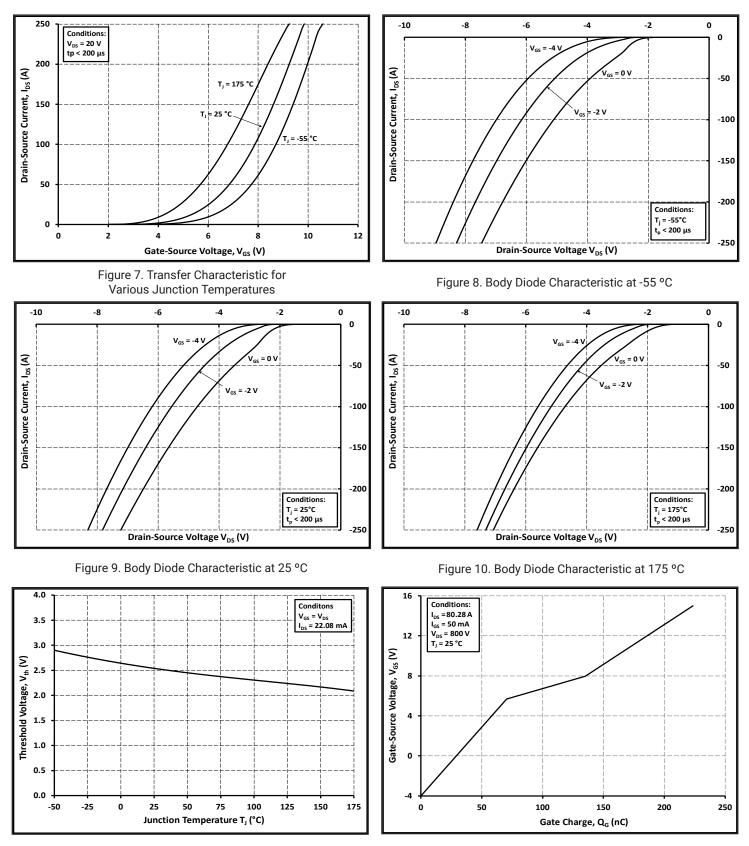
Figure 6. On-Resistance vs. Temperature For Various Gate Voltage

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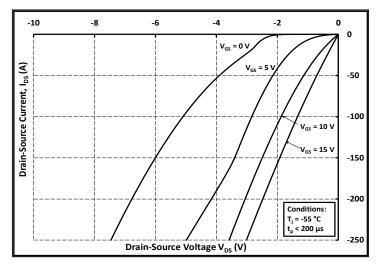


Figure 13. 3rd Quadrant Characteristic at -55 °C

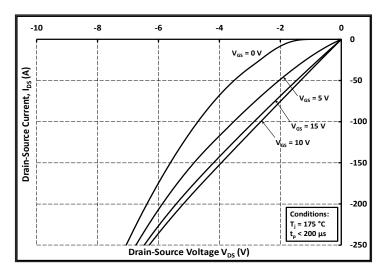
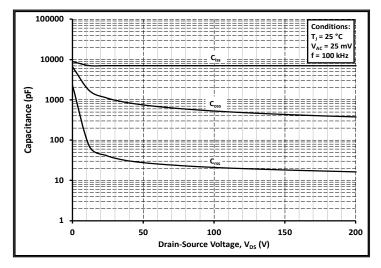
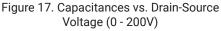


Figure 15. 3rd Quadrant Characteristic at 175 °C





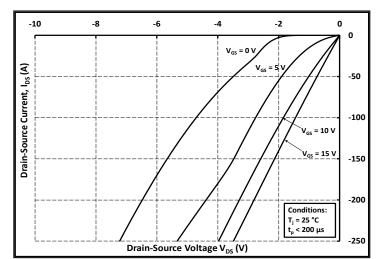


Figure 14. 3rd Quadrant Characteristic at 25 °C

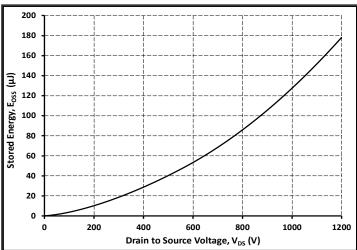


Figure 16. Output Capacitor Stored Energy

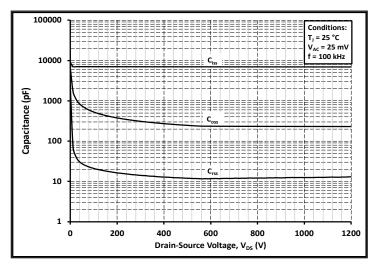
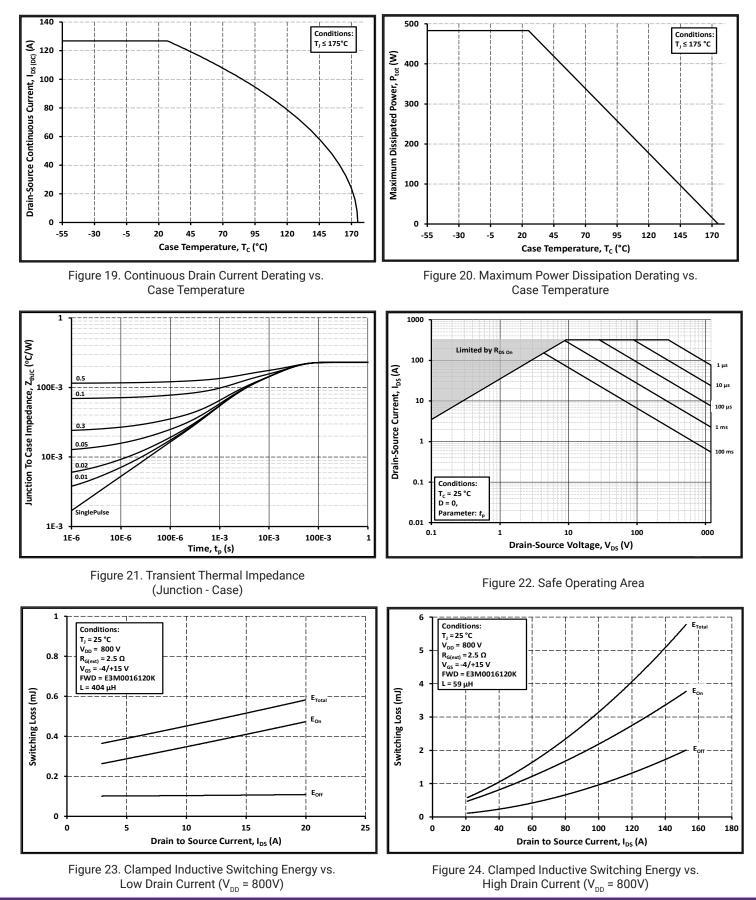


Figure 18. Capacitances vs. Drain-Source Voltage (0 - 1200V)

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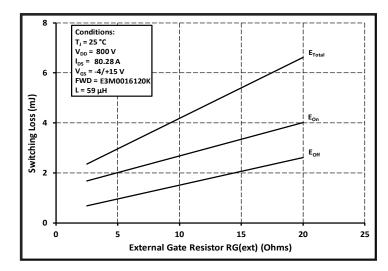


Figure 25. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

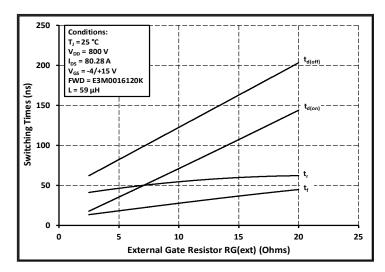


Figure 27. Switching Times vs. $R_{G(ext)}$

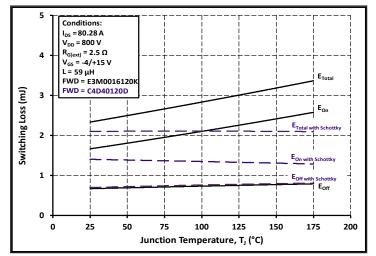


Figure 26. Clamped Inductive Switching Energy vs. Temperature

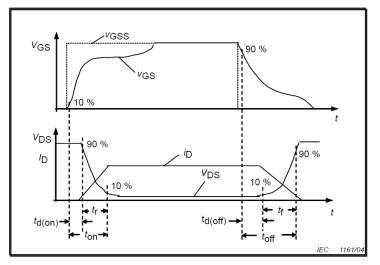


Figure 28. Switching Times Definition

Test Circuit Schematic



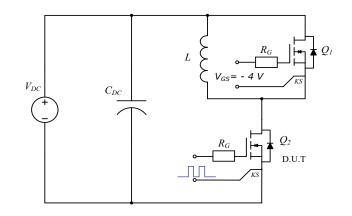
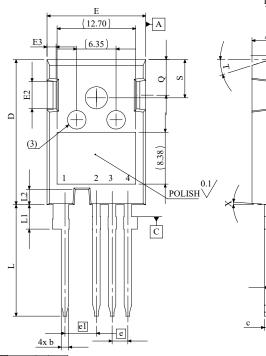
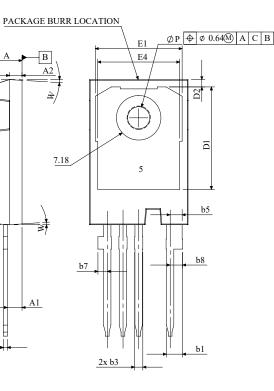


Figure 29. Clamped Inductive Switching Waveform Test Circuit

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Package Dimensions





⊕0.25M B AM

SYMBOL	MIN (mm)	MAX (mm)		
Α	4.83	5.21		
A1	2.29	2.54		
A2	1.91	2.16		
b	1.07	1.33		
b1	2.39	2.94		
b3	1.07	1.60		
b5	2.39	2.69		
b7	1.30	1.70		
b8	1.80	2.20		
с	0.55	0.68		
D	23.30	23.60		
D1	16.25	17.65		
D2	0.95	1.25		
E	15.75	16.13		
E1	13.1	14.15		
E2	3.68	5.10		
E3	1.00	1.90		
E4	12.38	13.43		
e	2.54 BSC			
e1		3 BSC		
L	17.31	17.82		
L1	3.97	4.37		
L2	2.35	2.65		
ØP	3.51	3.65		
Q	5.49	6.00		
S	6.04 6.30			
Т		° REF.		
W	3.5 ° REF.			
Х	4° REF.			

1	DRAIN
2	SOURCE
3	DRIVER SOURCE
4	GATE
5	DRAIN

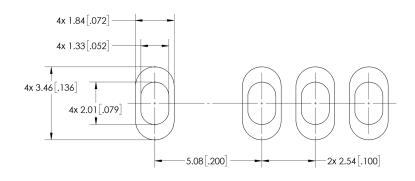
NOTE:

- 1. ALL METAL SURFACES ARE TIN PLATED (MATTE), EXCEPT AREA OF CUT.
- 2. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 3. ALL DIMENSIONS ARE LISTED IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 4. BURR OR MOLD FLASH SIZE (0.5 mm) IS NOT INCLUDED IN THE DIMENSIONS

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Recommended Solder Pad Layout



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Revision history

Document Version	Date of release	Descriptiion of changes
1.0	January-2023	Initial datasheet

Rev. 1, January 2023



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